

#4

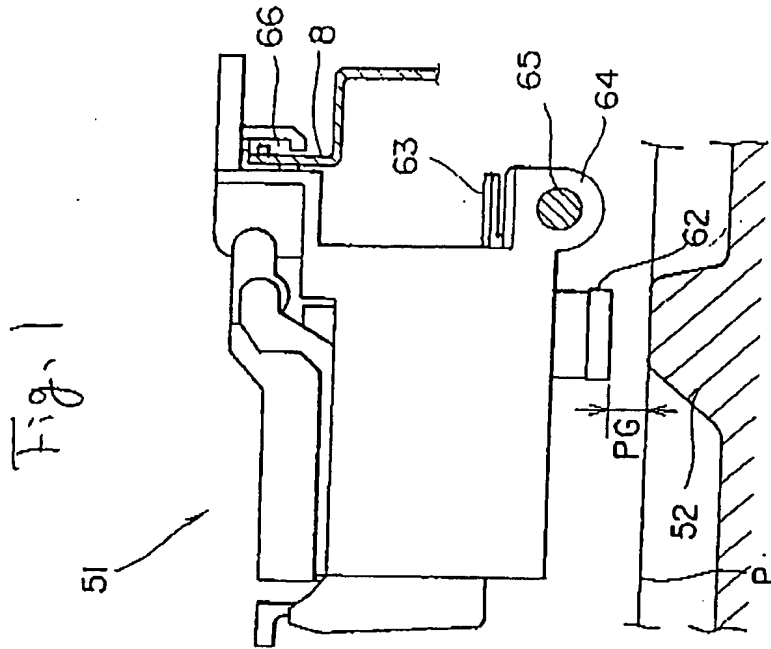


Fig. 2

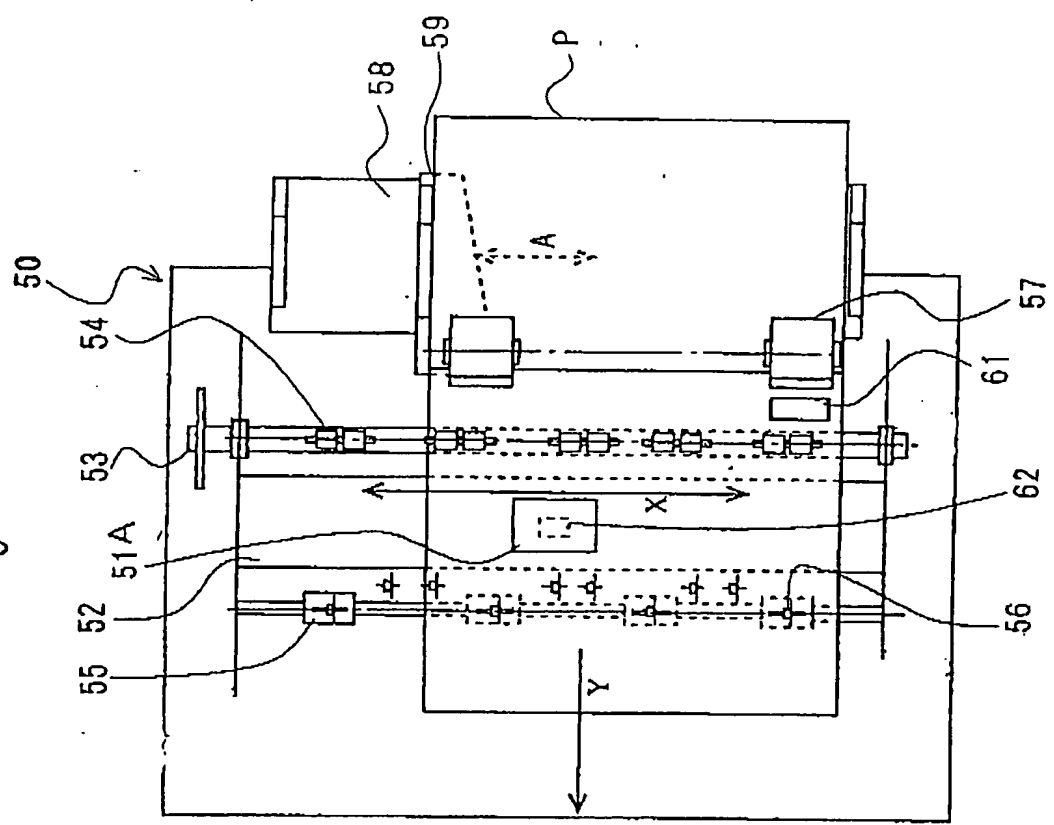
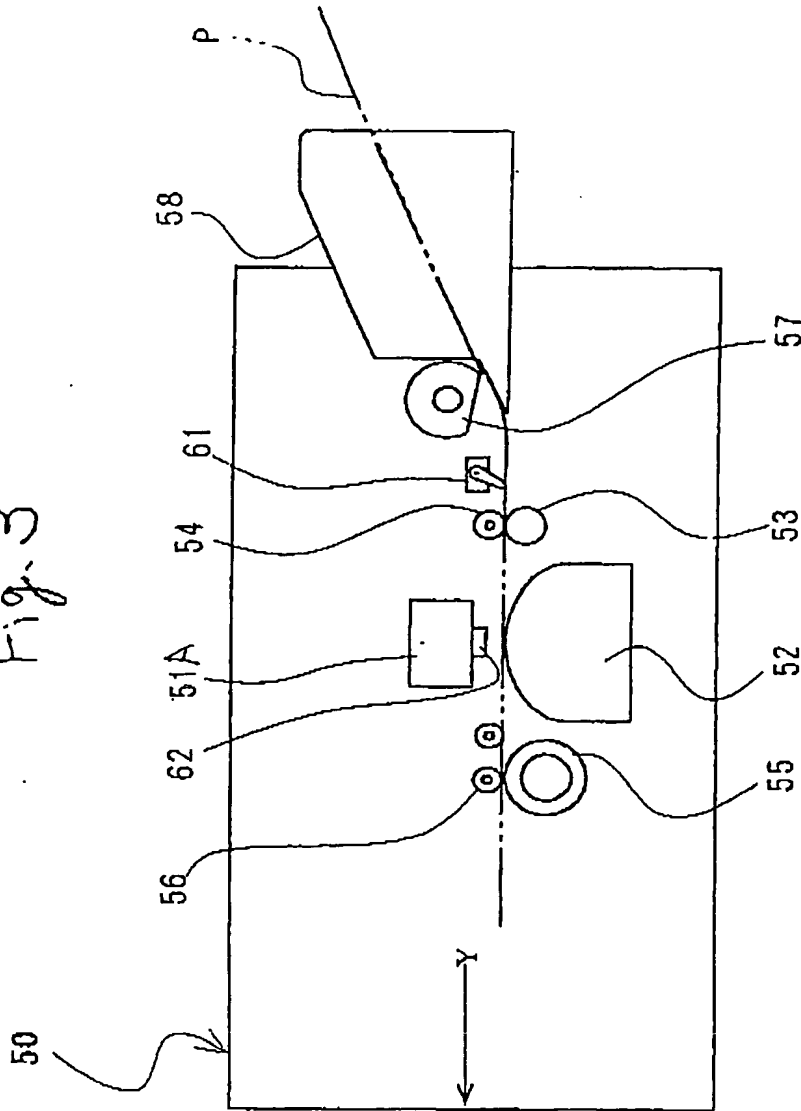


Fig. 3



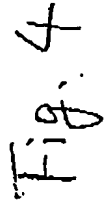




Fig. 6

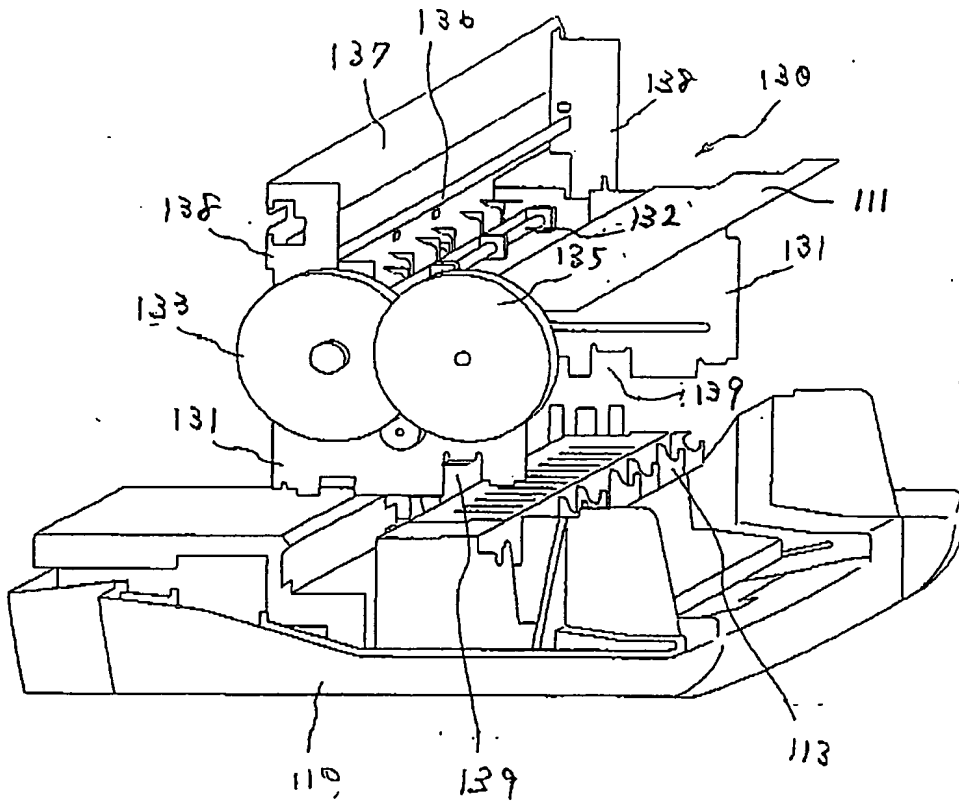


Fig. 7

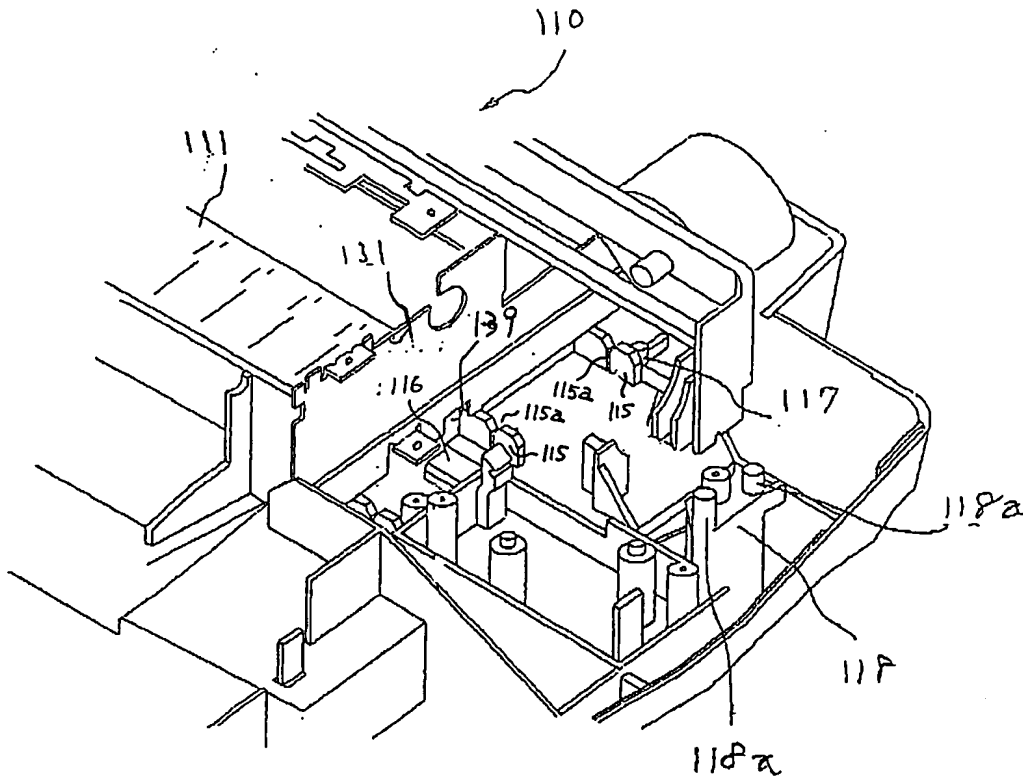
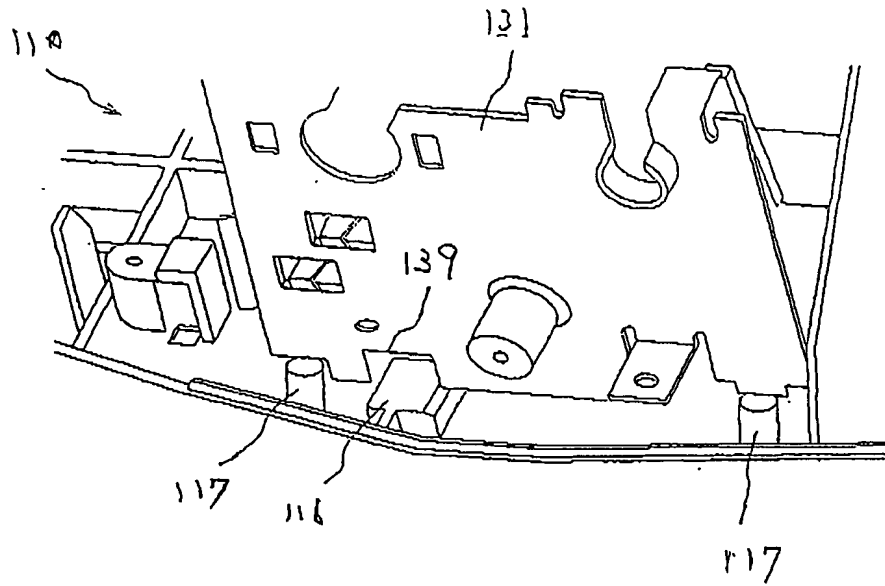


Fig. 8





This diagram shows an exploded perspective view of a multi-bay electronic device chassis. The main chassis body is labeled 201. It features a front panel with multiple bays. A front bezel or cover, labeled 204, is shown positioned to fit over the front of the chassis. Various internal components and connectors are shown in their relative positions. Labels 205 and 206 point to specific connector or mounting components on the left side. Label 209 points to a component within one of the bays. Label 211 points to the main chassis body, and label 212 points to a specific internal structure or connector. Label 214 points to a component on the right side of the chassis. The diagram illustrates how these components are assembled into the overall device.

Fig. 10

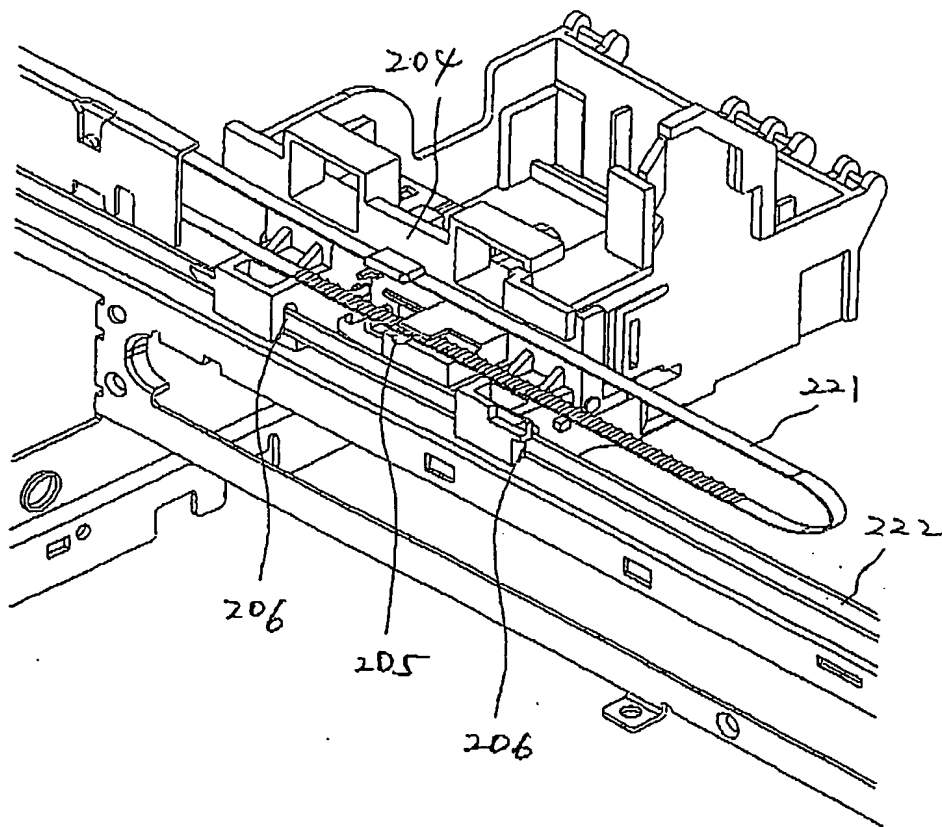


Fig. 11

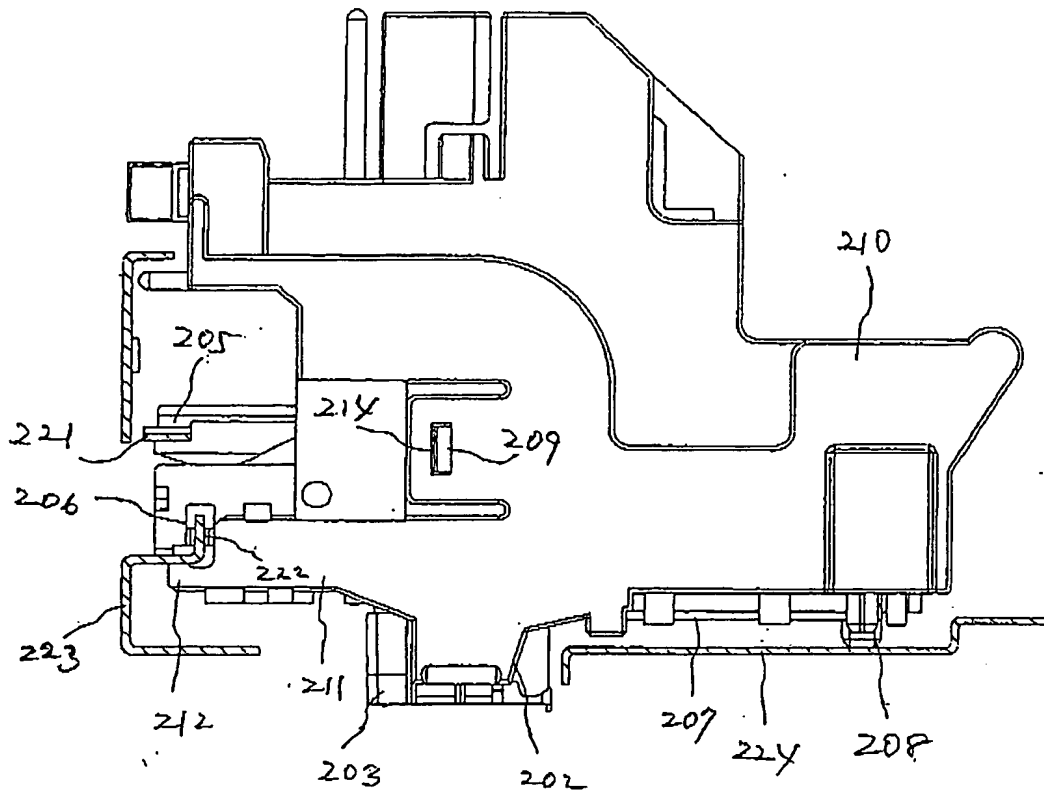


Fig. 12

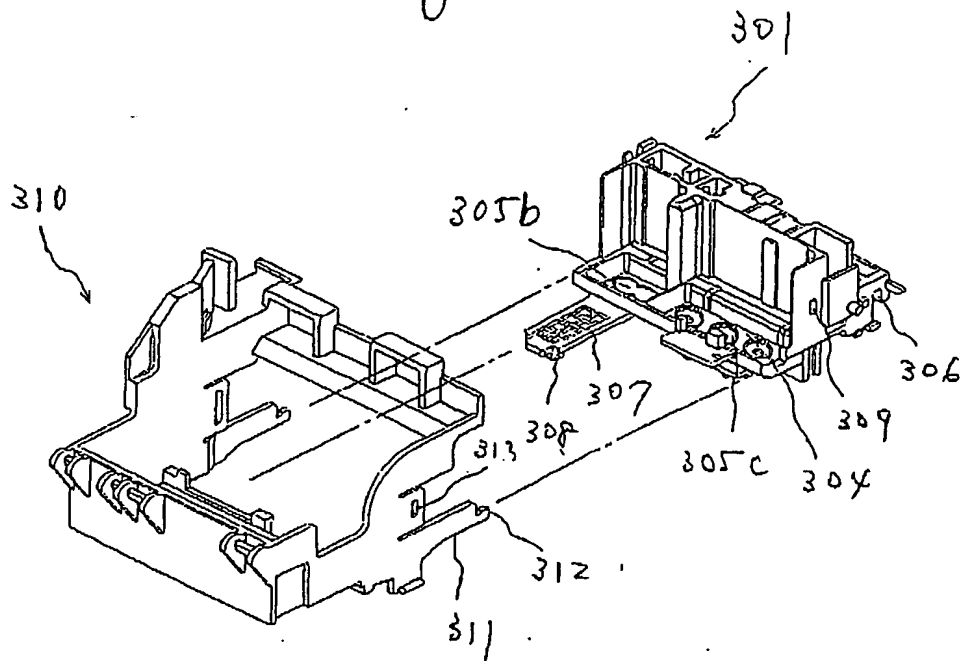


Fig. 13

